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Laser 3D Manufacturing II

Henry Helvajian
Alberto Piqué
Martin Wegener
Bo Gu
Editors

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The CID Number appears on each page of the manuscript. The complete citation is used on the first page, and an abbreviated version on subsequent pages.

Contents

v	<i>Authors</i>
vii	<i>Conference Committee</i>
ix	<i>Introduction</i>

SESSION 1	PROCESSES COMPATIBLE FOR LIFT AND ADDITIVE MANUFACTURING I: JOINT SESSION WITH CONFERENCES 9350 AND 9353
9353 03	2D/3D laser cutting of carbon fiber reinforced plastic (CFRP) by fiber laser irradiation [9353-1]
9353 04	Additive manufacturing in production: challenges and opportunities (Invited Paper) [9353-2]
SESSION 2	PROCESSES COMPATIBLE FOR LIFT AND ADDITIVE MANUFACTURING II: JOINT SESSION WITH CONFERENCES 9350 AND 9353
9353 07	Monolithic hybrid optics for broadband focusing and beam shaping [9353-5]
SESSION 3	3D MANUFACTURING METAL STRUCTURES
9353 0A	Femtosecond fiber laser additive manufacturing and welding for 3D manufacturing (Invited Paper) [9353-9]
9353 0B	Microstructural evolution and mechanical behavior of nickel-based superalloy 625 made by selective laser melting [9353-10]
SESSION 4	MECHANICAL METAMATERIALS I
9353 0F	Advantages and drawbacks of Thiol-ene based resins for 3D printing [9353-14]
SESSION 5	MECHANICAL METAMATERIALS AND DEVICES
9353 0K	Two-photon polymerization of hybrid polymers for applications in micro-optics [9353-19]
9353 0M	Three-dimensional two-photon laser fabrication for metals, polymers, and magneto-optical materials (Invited Paper) [9353-21]

SESSION 6	MATERIALS AND DEVICE FABRICATION
9353 0P	High resolution laser micro sintering/melting using q-switched and high brilliant laser radiation (Invited Paper) [9353-24]
SESSION 7	PROCESS DESIGN AND CERTIFICATION
9353 0U	Cellular scanning strategy for selective laser melting: generating reliable optimized scanning paths and processing parameters [9353-29]
SESSION 8	MICRO ENGINEERING AND PROCESS CONTROL
9353 0W	Microfabrication of three-dimensional filters for liposome extrusion (Invited Paper) [9353-31]
9353 0X	High power laser beam melting of Ti₆Al₄V on formed sheet metal to achieve hybrid structures [9353-32]
SESSION 9	PROCESS MONITORING
9353 12	Resolution enhancement through three color photolithography [9353-37]
9353 13	A study of transverse laser modes using a novel multi-scale simulation architecture for laser-based manufacturing technologies (Invited Paper) [9353-38]
	POSTER SESSION
9353 16	Evaluation of laser ultrasonic testing for inspection of metal additive manufacturing [9353-41]
9353 18	Contributions for the next generation of 3D metal printing machines [9353-43]

Authors

Numbers in the index correspond to the last two digits of the six-digit citation identifier (CID) article numbering system used in Proceedings of SPIE. The first four digits reflect the volume number. Base 36 numbering is employed for the last two digits and indicates the order of articles within the volume. Numbers start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B...0Z, followed by 10-1Z, 20-2Z, etc.

Adams, Paul, 0B	Steenhusen, Sönke, 0K
Ahuja, Bhriugu, 04, 0X	Streek, A., 0P
Albright, Thomas, 0B	Stucker, Brent, 13
Amemiya, Tomohiro, 0M	Sublette, Tim, 13
Anzai, Kenji, 03	Tanaka, Takuo, 0M
Aoyama, Mitsuaki, 03	Teng, Chong, 13
Bai, Shuang, 0A	Thombansen, U., 18
Baldacchini, Tommaso, 0W	Tomova, Zuleykhan, 12
Bläsius, Jana, 0F	Tuck, Chris, 16
Burmeister, Frank, 0K	Vullev, Valentine I., 0W
Dickens, Phill, 16	Wan, Peng, 0A
Dutton, Ben, 16	Wehner, Martin, 0F
Eckstein, Hans-Christoph, 0K	Witkin, David B, 0B
Engelhardt, Sascha, 0F	Yang, Lih-Mei, 0A
Everton, Sarah, 16	Zadoyan, Ruben, 0W
Exner, H., 0P	Zeng, Kai, 13
Fourkas, John T., 12	
Fuchs, U., 07	
Fujisaki, Akira, 03	
Furukawa, Koichi, 03	
Gillner, Arnold, 0F	
Grech, Joseph S., 0W	
Harada, Yoshihisa, 03	
Hattel, Jesper Henri, 0U	
Hoffmann, Andreas, 0F	
Houbertz, Ruth, 0K	
Huang, Huan, 0A	
Ishikawa, Atsushi, 0M	
Karg, Michael, 04, 0X	
Kayahara, Takashi, 03	
LaFratta, Christopher N., 0W	
Leonards, Holger, 0F	
Liu, Jian, 0A	
Matsushita, Masafumi, 03	
Merklein, Marion, 0X	
Miyato, Taizo, 03	
Mohanty, Sankhya, 0U	
Nie, Bai, 0A	
Niino, Hiroyuki, 03	
Nishino, Michiteru, 03	
Nuñez, Vicente, 0W	
Pal, Deepankar, 13	
Patil, Nachiket, 13	
Pereira, M., 18	
Pongratz, Ludwig, 0F	
Schaub, Adam, 0X	
Schmidt, Michael, 04, 0X	
Schmidt, Roman, 0X	
Schriever, Sascha, 0F	

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Session Chairs

- 1 Processes Compatible for LIFT and Additive Manufacturing I: Joint
Session with Conferences 9350 and 9353
Stephan Roth, BLZ Bayerisches Laserzentrum GmbH (Germany)
Henry Helvajian, The Aerospace Corporation (United States)
- 2 Processes Compatible for LIFT and Additive Manufacturing II: Joint
Session with Conferences 9350 and 9353
Beat Neuenschwander, Berner Fachhochschule Technik und
Informatik (Switzerland)
Henry Helvajian, The Aerospace Corporation (United States)

- 3 3D Manufacturing Metal Structures
Henry Helvajian, The Aerospace Corporation (United States)
- 4 Mechanical Metamaterials I
Martin Wegener, Karlsruher Institut für Technologie (Germany)
- 5 Mechanical Metamaterials and Devices
Martin Wegener, Karlsruher Institut für Technologie (Germany)
- 6 Materials and Device Fabrication
Bo Gu, Bos Photonics (United States)
- 7 Process Design and Certification
Bo Gu, Bos Photonics (United States)
- 8 Micro Engineering and Process Control
Alberto Piqué, U.S. Naval Research Laboratory (United States)
- 9 Process Monitoring
Alberto Piqué, U.S. Naval Research Laboratory (United States)

Introduction

At the second meeting of the Laser 3D Manufacturing conference, the following topical areas were addressed:

- manufacturing of metal structures
- mechanical metamaterials
- materials and device fabrication
- process design and certification
- micro-engineering
- process control and monitoring.

The formal portion of the conference comprised two full days, with an additional day to hold a joint session with the *Laser Applications in Microelectronic and Optoelectronic Manufacturing* (LAMOM) conference, which addressed the topic of Laser Induced Forward Transfer (LIFT) as it applies to 3D manufacturing. The goal of the conference remained the assembling of experts in topical areas pertinent to advancing 3D manufacturing. In our opinion, this includes not only addressing issues with regards to the manufacturing technique, but also those of process design, control, and monitoring. In the 2015 event, there was an increased focus in process control and monitoring to address industrial criticisms regarding process repeatability and reliability. The 3D manufacturing technique—whether it is by sintering (as for metals), or single photon or its high-finesse “cousin” two-photon polymerization for plastics—has already proven the complexity of shapes that can be realized (with feature sizes now measured down to tens of nanometers for polymers).

However, there were several industrial “concerns” that were voiced at the meeting.

- 1) How do we address the formation of imperceptible defects formed during manufacturing that render the part valueless upon an *ex situ* inspection?
- 2) How do we increase the poor surface finish of a 3D-formed metal part?
- 3) For high-precision 3D manufacturing (i.e., two-photon polymerization), how can we increase the fabrication throughput?

Various approaches to address these issues were presented: with process control and monitoring offering a means to solve the defect problem; the use of a high-power fs laser for 3D manufacturing to mitigate the surface finish issue and the use of specialty materials; oxygen quenching; and parallel light projection to enhance the speed of two-photon polymerization.

While the conference did address practical or industrial concerns, there were also new capabilities made possible by laser 3D processing. A few examples were described only to showcase the extent. Due to the high temperatures required, fusing tungsten powder/metal is difficult to accomplish with CW fiber lasers. Consequently, 3D metal parts made out of tungsten have not been demonstrated. However, the process becomes amenable when a high-power fs laser is used. Also, it is clear that nature applies hierarchical approaches to form structures. Several presentations addressed the development of high strength and lightweight hierarchical materials based on laser 3D manufacturing that could be applied to photonics and biomimetics; and many of the structures also have mechanical metamaterial properties. Finally, while it is the hardware and the techniques that continue to fascinate with the types of 3D structures that can be fabricated, it is the software logic, the CAD/CAM, and the simulations that permit the design of the complex shapes. Presentations addressed architecture for multiscale simulation and strategies for reliable selective melting.

3D manufacturing promises much, and many of these promises remain to be demonstrated. It is only through forums such as this conference where technical exchanges among the laser users, the materials developers, the tool manufacturers, and the software (CAD/CAM) and controls experts will decide what is of value. The Chairs thank our conference sponsor, PolarOnyx, Inc. of San Jose, California for their generous support and look forward to *3D Manufacturing III*, one year hence.

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Martin Wegener
Bo Gu